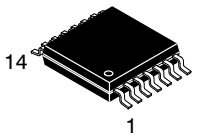
Dual D-Type Flip-Flop with Preset and Clear

74VHCT74A



TSSOP−14 WB
CASE 948G

General Description

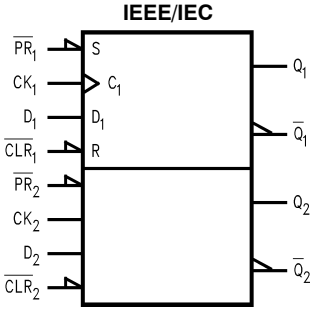
The VHCT74A is an advanced high speed CMOS Dual D−Type Flip−Flop fabricated with silicon gate CMOS technology. It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation. The signal level applied to the D INPUT is transferred to the Q OUTPUT during the positive going transition of the CK pulse. CLR and PR are independent of the CK and are accomplished by setting the appropriate input LOW.

Protection circuits ensure that 0 V to 5.5 V can be applied to the input pins without regard to the supply voltage and to the output pins with V_{CC} = 0 V. These circuits prevent device destruction due to mismatched supply and input/output voltages. This device can be used to interface 3 V to 5 V systems and two supply systems such as battery backup.

Features

- High Speed: f_{MAX} = 160 MHz (Typ.) at T_A = 25°C
- High Noise Immunity: V_{IH} = 2.0 V, V_{IL} = 0.8 V
- Power Down Protection is Provided on All Inputs and Outputs
- Low Power Dissipation: I_{CC} = 2 μA (max.) at T_A = 25°C
- Pin and Function Compatible with 74HCT74
- Pb−Free, Halogen Free/BFR Free and RoHS Compliant

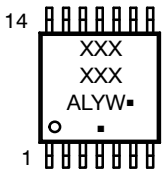
Logic Symbol



TRUTH TABLE

Inputs				Outputs		
$\overline{CLR}$	$\overline{PR}$	D	CK	Q	$\overline{Q}$	Function
L	H	X	X	L	H	Clear
H	L	X	X	H	L	Preset
L	L	X	X	H	H	
H	H	L	L	L	H	
H	H	H	L	H	L	
H	H	X	L	Q_n	Q_n	No Change

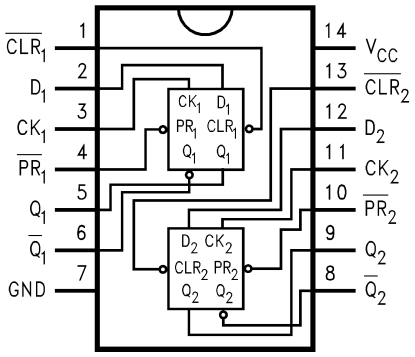
MARKING DIAGRAM



XXXXX = Specific Device Code
A = Assembly Location
L = Wafer Lot
Y = Year
W = Work Week
▪ = Pb−Free Package

(Note: Microdot may be in either location)

CONNECTION DIAGRAM



PIN DESCRIPTION

Pin Names	Description
D_1, D_2	Data Inputs
CK_1, CK_2	Clock Pulse Inputs
$\overline{CLR_1}$, $\overline{CLR_2}$	Direct Clear Inputs
$\overline{PR_1}$, $\overline{PR_2}$	Direct Preset Inputs
Q_1, $\overline{Q_1}$, Q_2, $\overline{Q_2}$	Outputs

ORDERING INFORMATION

See detailed ordering and shipping information on page 4 of this data sheet.

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ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Rating	Unit
V_{CC}	DC Supply Voltage	−0.5 to +6.5 V	V
V_I	DC Input Voltage	−0.5 to +6.5 V	V
V_O	DC Output Voltage Active Mode (High or Low State) Tristate Mode (Note 1) Power−Off Mode (V_{CC} = 0 V)	 −0.5 to V_{CC} +0.5 −0.5 to +6.5 −0.5 to +6.5	
I_{IN}	DC Input Current, per Pin	±20	mA
I_{OUT}	DC Input Current, per Pin	±25	mA
I_{CC}	DC Supply Current, V_{CC} or GND Pins	±50	mA
I_{IK}	Input Clamp Current	−20	mA
I_{OK}	Output Clamp Current	−20	mA
T_{STG}	Storage Temperature Range	−65 to +150	°C
T_L	Lead Temperature, 1 mm from Case for 10 seconds	260	°C
T_J	Junction Temperature Under Bias	+150	°C
θ_{JA}	Thermal Resistance (Note 2)	150	°C/W
P_D	Power Dissipation in Still Air at 25°C	833	mW
V_{ESD}	ESD Withstand Voltage (Note 3) Human Body Model Charged Device Model	 2000 N/A	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Applicable to devices with outputs that may be tri−stated.
2. Measured with minimum pad spacing on an FR4 board, using 76mm−by−114mm, 2−ounce copper trace no air flow per JESD51−7.
3. HBM tested to EIA / JESD22−A114−A. CDM tested to JESD22−C101−A. JEDEC recommends that ESD qualification to EIA/JESD22−A115A (Machine Model) be discontinued.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V_{CC}	DC Supply Voltage	4.5	5.5	V
V_{IN}	DC Input Voltage (Note 4)	0	5.5	V
V_{OUT}	DC Output Voltage Active Mode (High or Low State) Tristate Mode Power−Off Mode (V_{CC} = 0 V)	 0 0 0	 V_{CC} 5.5 5.5	V
T_A	Operating Temperature	−40	+85	°C
t_r, t_f	Input Rise or Fall Rate V_{CC} = 4.5 V to 5.5 V	0	20	ns/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

4. Unused inputs be held HIGH or LOW. They may not float.

DC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	V_{CC} (V)	Conditions		T_A = 25°C			T_A = −40°C to +85°C		Unit
					Min	Typ	Max	Min	Max	
V_{IH}	HIGH Level Input Voltage	4.5			2.0	–	–	2.0	–	V
		5.5			2.0	–	–	2.0	–	
V_{IL}	LOW Level Input Voltage	4.5			–	–	0.8	–	0.8	V
		5.5			–	–	0.8	–	0.8	
V_{OH}	HIGH Level Output Voltage	4.5	V_{IN} = V_{IH} or V_{IL}	I_{OH} = −50 μA	4.40	4.50	–	4.40	–	V
		4.5		I_{OH} = −8 mA	3.94	–	–	3.80	–	
V_{OL}	LOW Level Output Voltage	4.5	V_{IN} = V_{IH} or V_{IL}	I_{OL} = 50 μA	–	0.0	0.1	–	0.1	V
		4.5		I_{OL} = 8 mA	–	–	0.36	–	0.44	
I_{IN}	Input Leakage Current	0–5.5	V_{IN} = 5.5 V or GND		–	–	±0.1	–	±1.0	μA
I_{CC}	Quiescent Supply Current	5.5	V_{IN} = V_{CC} or GND		–	–	2.0	–	20.0	μA
I_{CCT}	Maximum I_{CC}/ Input	5.5	V_{IN} = 3.4 V, Other Inputs = V_{CC} or GND		–	–	1.35	–	1.50	mA
I_{OFF}	Output Leakage Current (Power Down State)	0.0	V_{OUT} = 5.5 V		–	–	±0.5	–	±5.0	μA

AC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	V_{CC} (V) (Note 5)	Conditions	T_A = 25°C			T_A = −40°C to +85°C		Unit
				Min	Typ	Max	Min	Max	
f_{MAX}	Maximum Clock Frequency	5.0	C_L = 15 pF	100	160	–	80	–	MHz
		5.0	C_L = 50 pF	80	140	–	65	–	
t_{PLH}, t_{PHL}	Propagation Delay Time (CK–Q, $\overline{Q}$)	5.0	C_L = 15 pF	–	5.8	7.8	1.0	9.0	ns
		5.0	C_L = 50 pF	–	6.3	8.8	1.0	10.0	
t_{PLH}, t_{PHL}	Propagation Delay Time ($\overline{CLR}$, $\overline{PR}$–Q, $\overline{Q}$)	5.0	C_L = 15 pF	–	7.6	10.4	1.0	12.0	ns
		5.0	C_L = 50 pF	–	8.1	11.4	1.0	13.0	
C_{IN}	Input Capacitance		V_{CC} = Open	–	4	10	–	10	pF
C_{PD}	Power Dissipation Capacitance		(Note 6)	–	24	–	–	–	pF

5. V_{CC} is 5.0 ± 0.5 V.
6. CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation:
   I_{CC} (opr.) = C_{PD} × V_{CC} × f_{IN} + I_{CC} / 2 (per flip–flop).

AC OPERATING REQUIREMENTS

Symbol	Parameter	V_{CC} (V)	T_A = 25°C		T_A = −40°C to 85°C	Unit
			Typ	Guaranteed Minimum		
t_W(L), t_W(H)	Minimum Pulse Width (CK)	5.0 ±0.5	–	5.0	5.0	ns
t_W(L)	Minimum Pulse Width ($\overline{CLR}$, $\overline{PR}$)	5.0 ±0.5	–	5.0	5.0	ns
t_S	Minimum Setup Time	5.0 ±0.5	–	5.0	5.0	ns
t_H	Minimum Hold Time	5.0 ±0.5	–	0	0	ns
t_{REM}	Minimum Removal Time ($\overline{CLR}$, $\overline{PR}$)	5.0 ±0.5	–	3.5	3.5	ns

ORDERING INFORMATION

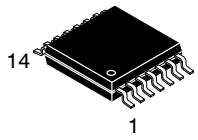
Device Order Number	Top Marking	Package Type	Shipping†
74VHCT74AMTCX	VHCT 74A	TSSOP−14 WB (Pb−Free, Halide Free)	2,500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

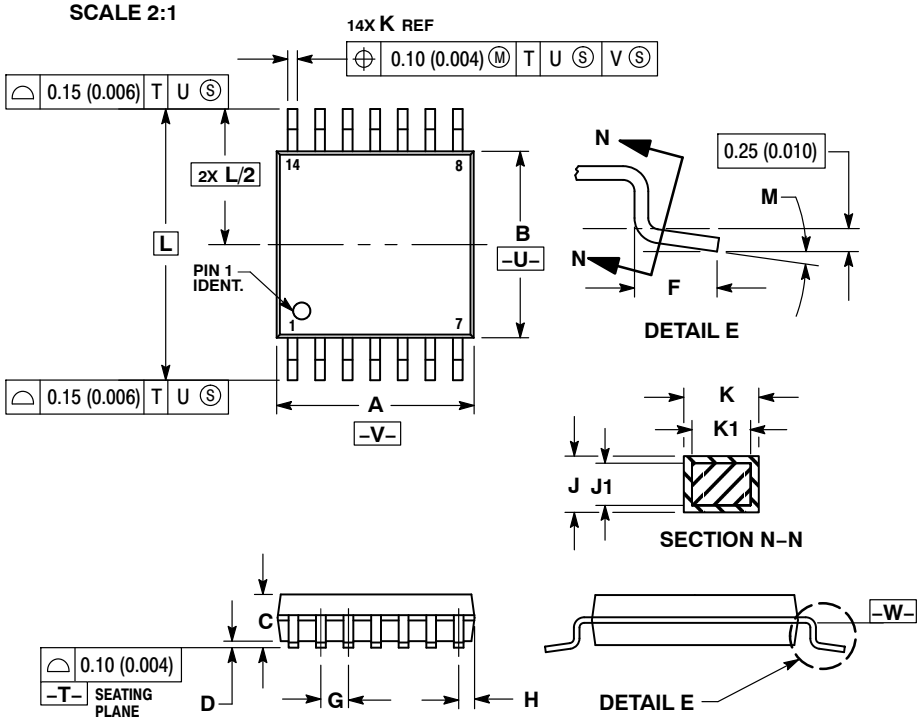
MECHANICAL CASE OUTLINE
PACKAGE DIMENSIONS

TSSOP−14 WB
CASE 948G
ISSUE C

DATE 17 FEB 2016



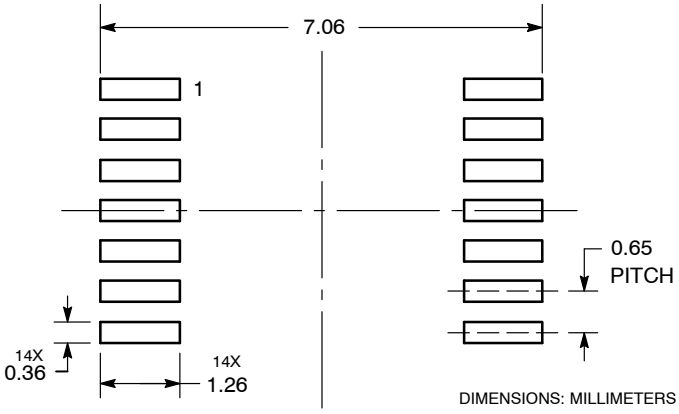
SCALE 2:1



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE −W−.

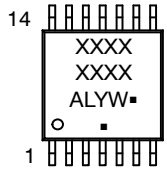
	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
A	4.90	5.10	0.193	0.200
B	4.30	4.50	0.169	0.177
C	−−−	1.20	−−−	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC		0.026 BSC	
H	0.50	0.60	0.020	0.024
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC		0.252 BSC	
M	0 °	8 °	0 °	8 °

SOLDERING FOOTPRINT



DIMENSIONS: MILLIMETERS

GENERIC MARKING DIAGRAM*



A = Assembly Location
L = Wafer Lot
Y = Year
W = Work Week
▪ = Pb−Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, “G” or microdot “▪”, may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	**TSSOP−14 WB**	**PAGE 1 OF 1**

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